	Туре	L#	Hits	Search Text	DBs	Time Stamp	C o m e i nt i s	ef ro	k
1	BRS	L1	1072	(etch\$3 or immers\$3) same "solder bumps"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/27 12:27		0	
2	BRS	L8	339	1 and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/27 11: 4 6		0	
3	BRS	L15	132	8 and @pd<=20000531	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/27 11: 4 7		0	
4	BRS	L22	2623317	(etch\$3 or immers\$3) same "solder bumps"same rotat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/27 12:30		0	
5	BRS	L29	1	(etch\$3 or immers\$3) with "solder bumps" with rotat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/27 12:31		0	